

N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)		
60	0.019 @ V _{GS} = 10 V	10		
	0.028 @ V _{GS} = 4.5 V	8.2		

FEATURES

- TrenchFET® Power MOSFET
- New Low Thermal Resistance
- PowerPAK® 1212-8 Package with Low 1.07-mm Profile
- 100% R_g Tested

 APPLICATIONS

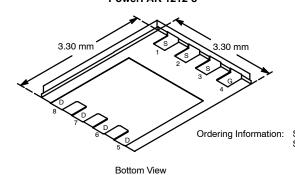
Primary Side Switch

• Synchronous Rectification

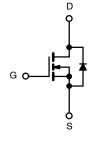


ROHS COMPLIANT

PowerPAK 1212-8



Si7120DN-T1 Si7120DN-T1—E3 (Lead (Pb)-Free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$ UNLESS OTHERWISE NOTED)						
Parameter		Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V _{DS}	60			
Gate-Source Voltage		V _{GS}	±20		V	
Outline During Owners (T. 45000)8	T _A = 25°C		10	6.3		
Continuous Drain Current (T _J = 150°C) ^a	T _A = 70°C	- I _D	8.0	5.1		
Pulsed Drain Current		I _{DM}	40		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	3.2	1.3		
Single Avalanche Current	1 0411	I _{AS}	22 24		mJ	
Single Avalanche Energy	L = 0.1 mH	E _{AS}				
W	T _A = 25°C	- P _D	3.8	1.5	w	
Maximum Power Dissipation ^a	T _A = 70°C		2.4	1.0		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C	
Soldering Recommendations (Peak Temperature)b,c			260		.0	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 10 sec	_	26	33		
Maximum Junction-to-Ambient ^a	Steady State	R _{thJA}	65	81	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.9	2.4		

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. See Solder Profile (http://www.vishay.com/doc?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.



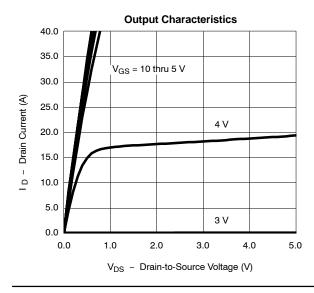
MOSFET SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)								
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
Static				-				
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.5	2.5	3.5	٧		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA		
7 O-t- \/-lk Du-i- O		V _{DS} = 60 V, V _{GS} = 0 V			1			
Zero Gate Voltage Drain Current	Dss	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			5	μA		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α		
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 10 A		0.015	0.019	Ω		
Dialit-Source Off-State Resistance		$V_{GS} = 4.5 \text{ V}, I_D = 8.2 \text{ A}$		0.023	0.028			
Forward Transconductancea	9 _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 10 \text{ A}$		35		S		
Diode Forward Voltage ^a	V _{SD}	I _S = 3.2 A, V _{GS} = 0 V		0.78	1.2	V		
Dynamic ^b	<u> </u>							
Total Gate Charge	Qg			30	45	nC		
Gate-Source Charge	Q _{gs}	V_{DS} = 10 V, V_{GS} = 10 V, I_{D} = 10 A		6.9				
Gate-Drain Charge	Q _{gd}			5.8				
Gate Resistance	R _g		0.65	1.3	1.95	Ω		
Turn-On Delay Time	t _{d(on)}			14	25			
Rise Time	t _r	$V_{DD} = 30 \text{ V, R}_{1} = 30 \Omega$		12	20	ns		
Turn-Off Delay Time	t _{d(off)}	V_{DD} = 30 V, R_L = 30 Ω I_D \cong 1 A, V_{GEN} = 10 V, R_g = 6 Ω		50	80			
Fall Time	t _f			12	20			
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 3.2 A, di/dt = 100 A/μs		60	100			

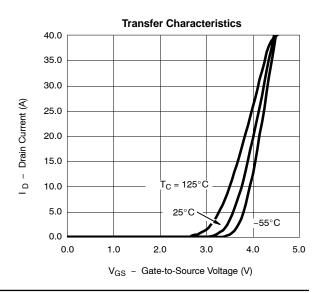
Notes

- Pulse test; pulse width $\leq 300 \, \mu s$, duty cycle $\leq 2\%$. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

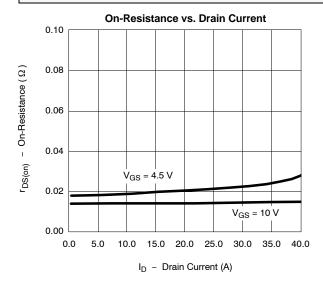


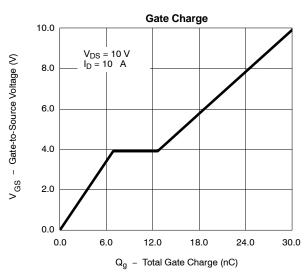


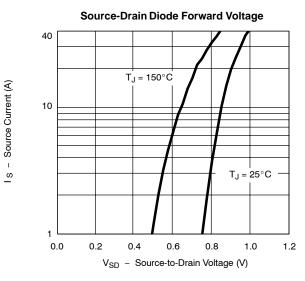


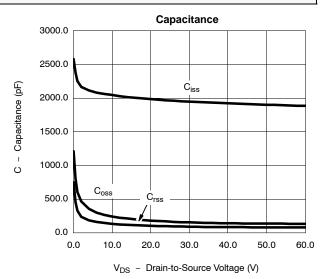


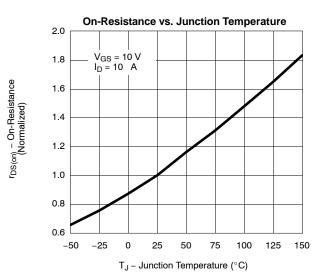
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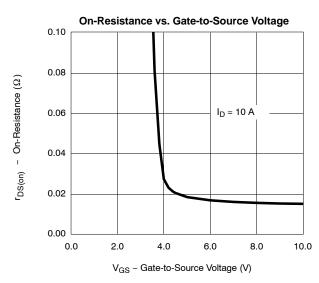






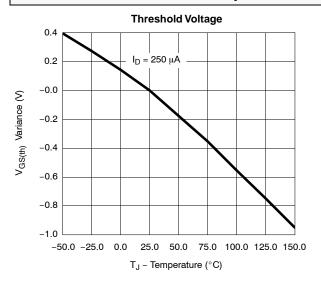


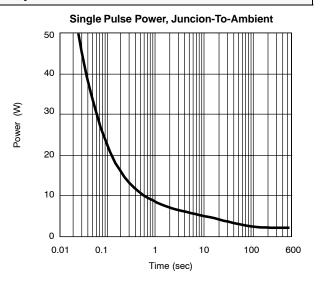


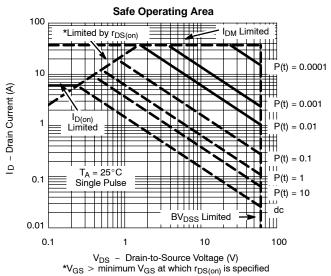




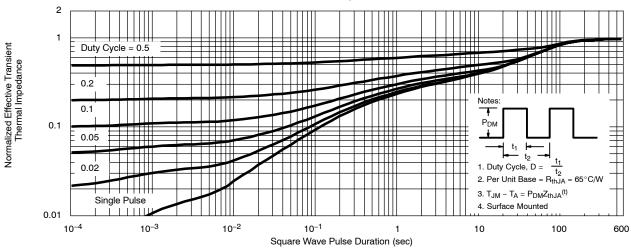
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)







Normalized Thermal Transient Impedance, Junction-to-Ambient





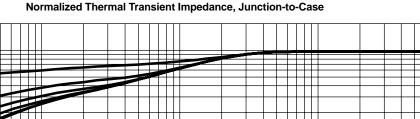
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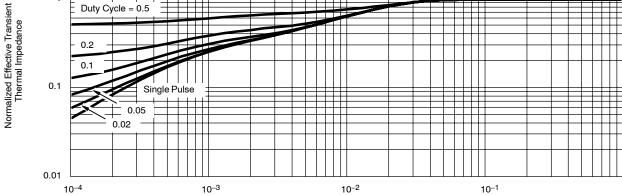
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Duty Cycle = 0.5

Vishay Siliconix

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)





Square Wave Pulse Duration (sec)

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72771.

Legal Disclaimer Notice



Vishay

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